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THE COMMISSIONER OF PATENTS AND TRADEMARKS
Washington, D.C. 20231Docket No. MEG2000-012

J1040 U.S. PTO

09/821546

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Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: JIN YUAN LEE, CHING CHENG HUANG, MOU SHIANG LIN

For: A STRUCTURE AND MANUFACTURING METHOD OF CHIP SCALE PACKAGE

Enclosed are:

- ☒ 10 sheets of drawing(s) - formal.
- ☒ An assignment of the invention to MEGIC CORPORATION
- ☐ An associate power of attorney ☒ Applicant claims small entity status
- ☐ Request & Certification under 35 USC 122(b) (2) (b) (i)

The filing fee has been calculated as shown below:

| | (Col. 1) | (Col. 2) | SMALL ENTITY | |
|------------------------------------|-----------|-----------|--------------|---------|
| FOR: | NO. FILED | NO. EXTRA | RATE | FEE |
| BASIC FEE | | | | \$ 345. |
| TOTAL CLAIMS | 41 -20= | 21 | x 9 = | \$ 189. |
| INDEP CLAIMS | 3 -3= | 0 | x 40 = | \$ 0. |
| MULTIPLE DEPENDENT CLAIM PRESENTED | | | + 260 = | |
| | | | SUB TOTAL | \$ 534. |
| | | | ASSIGNMENT | \$40. |
| | | | TOTAL | \$574. |

- ☒ Please charge my Deposit Account No. 19-0033 in the amount of \$ 574. A duplicate copy of this sheet is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 CFR \$1.16.
- ☒ Any patent application processing fees under 37 CFR \$1.17.

Respectfully submitted,

STEPHEN B. ACKERMAN, REG. NO. 37,761